

# **Data Sheet**

# **Description**

The FMET-23010 is a 100 V, 30 A Schottky diode with a trench structure, allowing improvements in V<sub>F</sub> and  $I_R$  characteristics. These characteristic features contribute to improving power supply efficiency and to enabling high-frequency systems.

#### **Features**

• V <sub>RSM</sub>	100 V
• I <sub>F(AV)</sub>	30 A
	0.81 V typ.
1 (-1 )	7.T

• Bare lead frame: Pb-free (RoHS compliant)

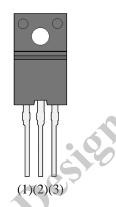
# **Applications**

Agit Reconning to the second s The high speed switching applications as follows:

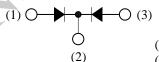
- DC-DC Converter
- Adapter

# **Package**

TO220F-3L



Not to scale



- (1) Anode
- (2) Cathode
- (3) Anode

#### **FMET-23010**

# **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C.

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage <sup>(1)</sup>	V <sub>RSM</sub>	100	V	
Repetitive Reverse Voltage <sup>(1)</sup>	$V_{RM}$	100	V	
Average Forward Current <sup>(2)</sup>	I <sub>F(AV)</sub>	30	A	See Figure 1 and Figure 2
Surge Forward Current <sup>(1)</sup>	$I_{FSM}$	120	A	Half cycle sine wave, positive side, 10 ms, 1 shot
I <sup>2</sup> t Limiting Value <sup>(1)</sup>	$I^2t$	72	$A^2s$	$1 \text{ ms} \le t \le 10 \text{ ms}$
Junction Temperature	$T_{J}$	-40 to 150	°C	.5
Storage Temperature	$T_{STG}$	-40 to 150	°C	. 6

#### **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C.

Offices office wise specified, $T_A = 25^\circ$ C	•		4	/			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Forward Voltage Drop <sup>(1)</sup>	$V_{F}$	I <sub>F</sub> = 15 A	<u>V</u> _	0.81	0.85	V	
Reverse Leakage Current <sup>(1)</sup>	$I_R$	$V_R = V_{RM}$	_		100	μΑ	
Reverse Leakage Current under High Temperature <sup>(1)</sup>	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_		50	mA	
Thermal Resistance <sup>(3)</sup>	$R_{\text{th}(J\text{-}C)}$				4.0	°C/W	
Thermal Resistance <sup>(3)</sup> R <sub>th(J-C)</sub> — 4.0 °C/W							

<sup>&</sup>lt;sup>(1)</sup> Specifies a value per chip; the FMET-23010 consists of two chips.
<sup>(2)</sup> Specifies a value of the two chips configuring the product; a value per chip is 15 A.

 $<sup>^{(3)}</sup>R_{th (J-C)}$  is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

# **Rating and Characteristic Curves**

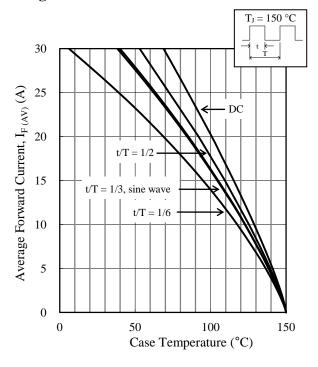


Figure 1.  $T_C \text{ vs. } I_{F(AV)} \text{ Typical Characteristics } (V_R = 0 \text{ V})$ 

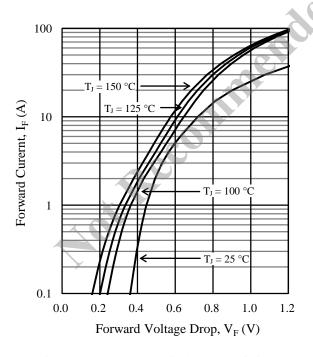


Figure 3. V<sub>F</sub> vs. I<sub>F</sub> Typical Characteristics

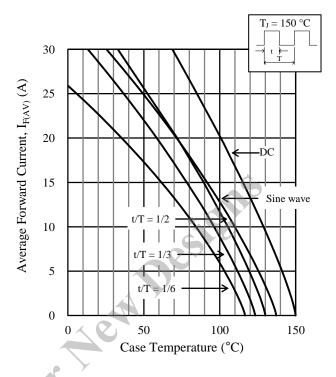


Figure 2.  $T_C \text{ vs. } I_{F(AV)} \text{ Typical Characteristics}$   $(V_R = 100 \text{ V})$ 

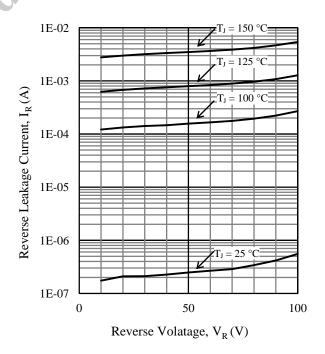
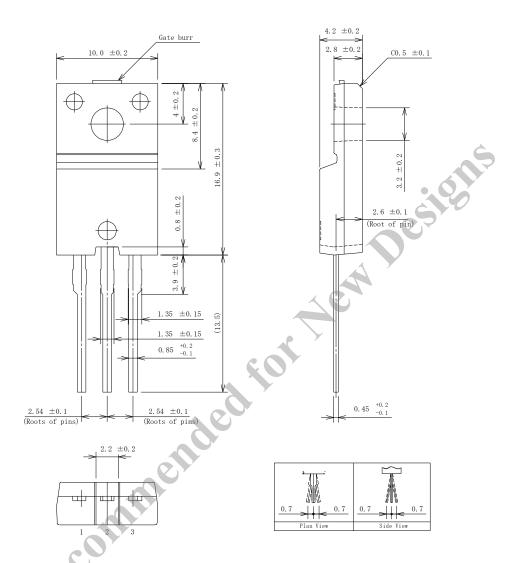


Figure 4. V<sub>R</sub> vs. I<sub>R</sub> Typical Characteristics

# **Physical Dimensions**

#### • TO220F



#### **NOTES:**

- Dimensions in millimeters
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits:

Flow:  $260 \pm 5 \, {}^{\circ}\text{C} / 10 \pm 1 \, \text{s}, 2 \, \text{times}$ 

Soldering Iron:  $380 \pm 10$  °C /  $3.5 \pm 0.5$  s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

Recommended screw torque for TO220F: 0.490 N·m to 0.686 N·m (5 kgf·cm to 7 kgf·cm)

# **Marking Diagram**

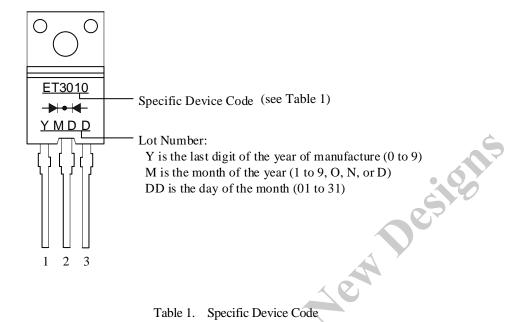


Table 1. Specific Device Code

Specific Device Code	Part Number
ET3010	FMET-23010
Recolling	

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